

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Osamu OKUNAKA	03/30/2009
Hiroyuki NISHII	03/30/2009
Takashi SHOUJI	03/30/2009
Keiji NAKAMURA	03/30/2009
Tae Uk KIM	03/30/2009
Byung Choon LEE	03/30/2009

RECEIVING PARTY DATA

Name:	Mitsubishi Rayon Co., Ltd.
Street Address:	6-41, Konan 1-chome, Minato-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	108-8506

Name:	CHEIL INDUSTRIES INC.
Street Address:	290, Gongdan-dong
City:	Gumi-si, Gyeongsangbuk-do
State/Country:	REPUBLIC OF KOREA
Postal Code:	730710

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12439089

CORRESPONDENCE DATA

Fax Number: (703)413-2220

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (703) 413-3000

OP \$40.00 12439089

500858135

PATENT
REEL: 022673 FRAME: 0733

Email:	ajoya@oblon.com
Correspondent Name:	Oblon, Spivak, et al.
Address Line 1:	1940 Duke Street
Address Line 4:	Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:	338729US
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NAME OF SUBMITTER:	Abdul Joya
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Total Attachments: 4
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source=338729USAssignment#page4.tif

Assignment of Application

Page 1 of 2

WHEREAS, I (WE) (1) Osamu OKUNAKA of Toyohashi-shi, Japan ;
(2) Hiroyuki NISHII of Ootake-shi, Japan ;
(3) Takashi SHOUJI of Ootake-shi, Japan;
(4) Keiji NAKAMURA of Ootake-shi, Japan
(5) Tae Uk KIM of Suwon-si, Korea; and
(6) Byung Choon LEE of Anyang-Si, Korea

INSERT NAMES
AND RESIDENCE
ADDRESS OF
THE INVENTORS.

_____, respectively,

INSERT TITLE
OF INVENTION:

have invented certain new and useful improvements in: IMPACT RESISTANCE IMPROVER, THERMOPLASTIC
RESIN COMPOSITION, SHAPED ARTICLE AND METHOD FOR PRODUCING GRAFT COPOLYMER

INSERT DATE IN-
VENTORS SIGNED
DECLARATION:

for which an application for Letters Patent was executed on _____

(Application No. _____, filed _____), and

INSERT NAME
AND ADDRESS OF
COMPANY OR
OTHER ASSIGNEE

WHEREAS, (1) Mitsubishi Rayon Co., Ltd. and (2) CHEIL INDUSTRIES INC.

(hereinafter referred to as "ASSIGNEE") having a place of business at: (1) of 6-41, Konan 1-chome, Minato-ku,
Tokyo 108-8506 Japan and (2) of 290, Gongdan-dong, Gumi-si, Gyeongsangbuk-do 730710 Republic of Korea

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

03/03

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of Oblon, Spivak, McClelland, Maier & Neustadt, P.C. of 1940 Duke Street Alexandria, Virginia 22314 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: March 30, 2009

Osamu Okunaka
(Signature of Inventor) Osamu OKUNAKA

Date: March 30, 2009

Hiroyuki Nishii
(Signature of Inventor) Hiroyuki NISHII

Date: March 30, 2009

Takashi Shouji
(Signature of Inventor) Takashi SHOUJI

Date: March 30, 2009

Keiji Nakamura
(Signature of Inventor) Keiji NAKAMURA

Date: _____

(Signature of Inventor) Tae Uk KIM

Date: _____

(Signature of Inventor) Byung Choon LEE

Date: _____

(Signature of Inventor)

Date: _____

(Signature of Inventor)

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.
ATTORNEYS AT LAW
1940 DUKE STREET
ALEXANDRIA, VIRGINIA 22314

03/03

USP-29169
US(註)1/2

Assignment of Application

Page 1 of 2

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Date: _____	(Signature of Inventor) Osamu OKUNAKA
Date: _____	(Signature of Inventor) Hiroyuki NISHII
Date: _____	(Signature of Inventor) Tadashi SHOUJI
Date: _____	(Signature of Inventor) Keiji NAKAMURA
Date: March 30, 2009	(Signature of Inventor) <i>Tae Uk Kim</i> Tae Uk KIM
Date: March 30, 2009	(Signature of Inventor) <i>Byung-Choon LEE</i> Byung Choon LEE
Date: _____	(Signature of Inventor) _____
Date: _____	(Signature of Inventor) _____

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.
ATTORNEYS AT LAW
1940 DUKE STREET
ALEXANDRIA, VIRGINIA 22314

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